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Attorney's Docket No. 5649-968

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Lee et al.
Serial No.: 10/046,805
Filed: January 14, 2002

Group Art Unit:
Examiner: To Be Assigned

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TC 2800 MAIL ROOM
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For: METHODS OF FORMING METAL LAYERS IN INTEGRATED CIRCUIT
DEVICES USING SELECTIVE ELECTROPLATING ON EDGES OF RECESSES
AND CONDUCTIVE CONTACTS SO FORMED

Date: February 18, 2002

Commissioner for Patents
Washington, DC 20231
Attn: Drawing Review Branch

SUBMITTAL OF FORMAL DRAWINGS

Sir:

Enclosed herewith is one set (11 sheets) of new formal drawings. It is requested that these new drawings be substituted for the originally filed informal drawings.

Respectfully submitted,

Robert N. Crouse
Registration No. 44,635



20792

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, Attn: Drawing Review Branch, on February 18, 2002.

Candi L. Riggs
Date of Signature: February 18, 2002